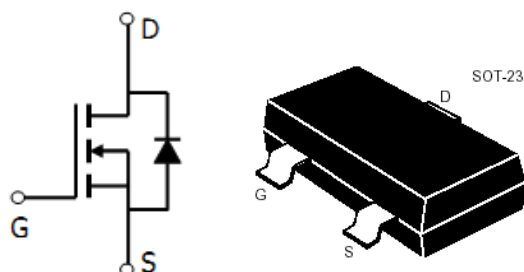


N-Channel Enhancement-Mode MOSFETs



■ MAXIMUM RATINGS

Characteristic	Symbol	Max	Unit
Drain-Source Voltage	BV_{DSS}	20	V
Gate- Source Voltage	V_{GS}	± 8	V
Drain Current (continuous)	I_D	4.2	A
Drain Current (pulsed)	I_{DM}	16	A
Total Device Dissipation $T_A=25^\circ\text{C}$	P_D	1200	mW
Junction	T_J	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55to+150	$^\circ\text{C}$

■ DEVICE MARKING

SL3414A=A14

■ ELECTRICAL CHARACTERISTICS

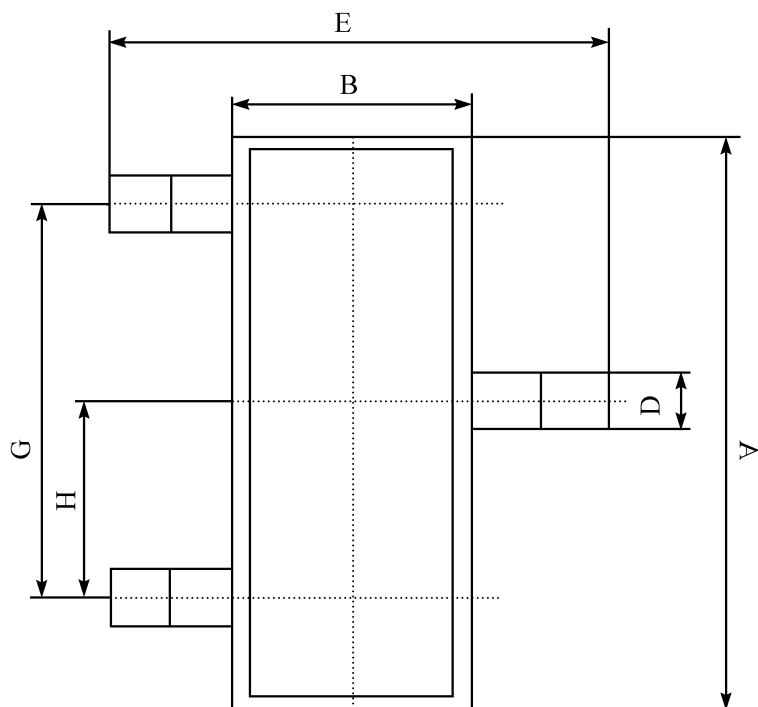
($T_A=25^{\circ}\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage ($I_D = 250\mu\text{A}, V_{GS}=0\text{V}$)	BV_{DSS}	20	—	—	V
Gate Threshold Voltage ($I_D = 250\mu\text{A}, V_{GS}=V_{DS}$)	$V_{GS(th)}$	0.4	0.6	1	V
Diode Forward Voltage Drop ($I_S = 1\text{A}, V_{GS}=0\text{V}$)	V_{SD}	—	—	1	V
Zero Gate Voltage Drain Current ($V_{GS}=0\text{V}, V_{DS}=16\text{V}$) ($V_{GS}=0\text{V}, V_{DS}=16\text{V}, T_A=55^{\circ}\text{C}$)	I_{DSS}	—	—	1 5	μA
Gate Body Leakage ($V_{GS}=\pm 8\text{V}, V_{DS}=0\text{V}$)	I_{GSS}	—	—	± 100	nA
Static Drain-Source On-State Resistance ($I_D=4.2\text{A}, V_{GS}=4.5\text{V}$) ($I_D=3.7\text{A}, V_{GS}=2.5\text{V}$) ($I_D=3.2\text{A}, V_{GS}=1.8\text{V}$)	$R_{DS(on)}$	—	41 52 67	50 63 87	$\text{m}\Omega$
Input Capacitance ($V_{GS}=0\text{V}, V_{DS}=10\text{V}, f=1\text{MHz}$)	C_{ISS}	—	436	—	pF
Common Source Output Capacitance ($V_{GS}=0\text{V}, V_{DS}=10\text{V}, f=1\text{MHz}$)	C_{OSS}	—	66	—	pF
Turn-ON Time ($V_{DS}=10\text{V}, V_{GS}=5\text{V}, R_{GEN}=6\Omega$)	$t_{(on)}$	—	5.5	—	ns
Turn-OFF Time ($V_{DS}=10\text{V}, V_{GS}=5\text{V}, R_{GEN}=6\Omega$)	$t_{(off)}$	—	40	—	ns

Pulse Width $\leq 300\mu\text{s}$; Duty Cycle $\leq 2.0\%$

■ DIMENSION

(UNIT): mm



序號	數值及公差
A	2.90 ± 0.10
B	1.30 ± 0.10
C	1.00 ± 0.10
D	0.40 ± 0.10
E	2.40 ± 0.20
G	1.90 ± 0.10
H	0.95 ± 0.05
J	0.13 ± 0.05
K	$0.00 - 0.10$
M	≥ 0.2
N	0.60 ± 0.10
P	$7 \pm 2^\circ$

